

FCA170S25D1

eSiC Silicon Carbide Schottky Diode

1700V, 25A



Description

The 1700V eSiC Diode is an advanced Faster Semiconductor's silicon carbide diode family. This technology combines the benefits of excellent low forward voltage and robustness. Consequently, the eSiC Diode is suitable for application requiring high power efficiency.

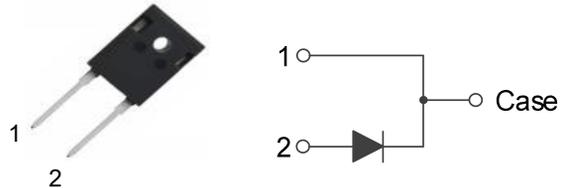
Features

V_{RRM}	I_F	$T_{J,max}$	Q_C
1700 V	25 A	175 °C	173 nC

- No reverse recovery current
- Low forward voltage
- 175°C Max junction temperature
- High surge current capability
- Independent-temperature switching behavior
- Pb-Free, Halogen Free and RoHS compliant

Applications

- Solar inverter, UPS
- EV charging station
- Power Factor Correction



Absolute Maximum Ratings ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1700	V
I_F	Forward Current	$T_C = 151^\circ\text{C}$ 25	A
$I_{F,SM}$	Non-Repetitive Forward Surge Current	$T_C = 25^\circ\text{C}, t_p = 10\text{ ms}$	191
		$T_C = 150^\circ\text{C}, t_p = 10\text{ ms}$	162
$I_{F,Max}$	Non-Repetitive Peak Forward Current	$T_C = 25^\circ\text{C}, t_p = 10\text{ us}$	1377
		$T_C = 150^\circ\text{C}, t_p = 10\text{ us}$	1170
I^2dt value	$\int I^2 dt$	$T_C = 25^\circ\text{C}, t_p = 10\text{ ms}$	182
		$T_C = 150^\circ\text{C}, t_p = 10\text{ ms}$	131
P_{tot}	Power Dissipation	$T_C = 25^\circ\text{C}$ 294	W
T_J, T_{STG}	Operating Junction and Storage Temperature	-55 to +175	°C

Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.51	°C/W

Package Marking and Ordering Information

Part Number	Top Marking	Package	Packing Method	Quantity
FCA170S25D1	FCA170S25D1	TO-247-2L	Tube	30 units

Electrical Characteristics (Per Leg, $T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_F	Forward Voltage	$I_F=25\text{ A}, T_C=25^\circ\text{C}$		1.5	1.8	V
		$I_F=25\text{ A}, T_C=175^\circ\text{C}$		2.1	-	
I_R	Reverse Current	$V_R=1700\text{ V}, T_C=25^\circ\text{C}$		-	100	μA
		$V_R=1700\text{ V}, T_C=175^\circ\text{C}$		-	300	
Q_C	Total Capacitive Charge	$V_R=800\text{ V}, T_C=25^\circ\text{C}$		173		nC
C	Total Capacitance	$V_R=1\text{ V}, f=100\text{ kHz}$		2005		pF
		$V_R=800\text{ V}, f=100\text{ kHz}$		114		
E_C	Capacitance Stored Energy	$V_R=800\text{ V}, T_C=25^\circ\text{C}$		48.6		μJ

Typical Performance Characteristics

Figure 1. Power Derating

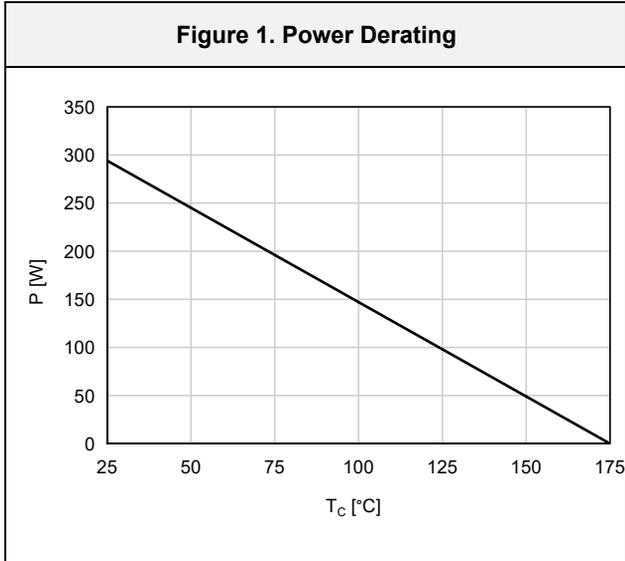


Figure 2. Current Derating

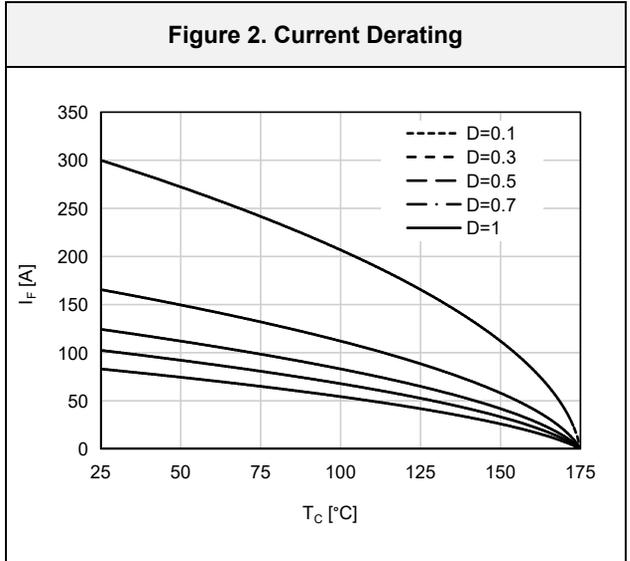


Figure 3. Forward Characteristics

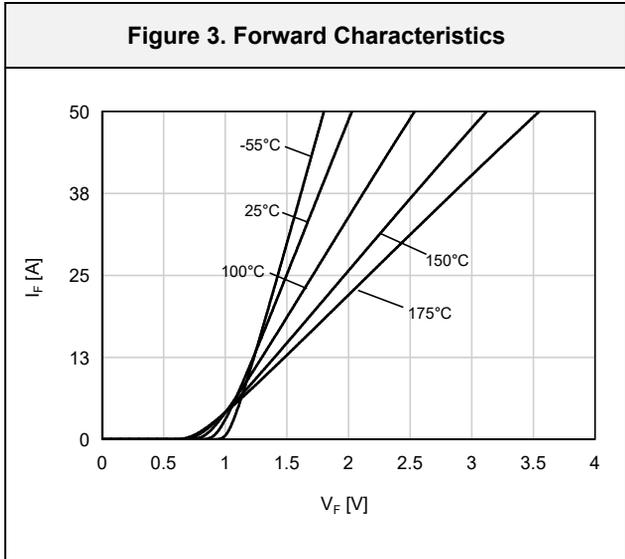


Figure 4. Reverse Characteristics

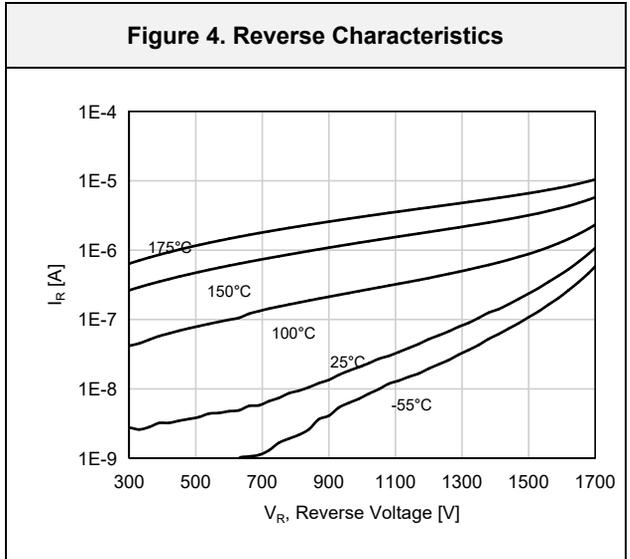


Figure 5. Capacitive Charge Characteristics

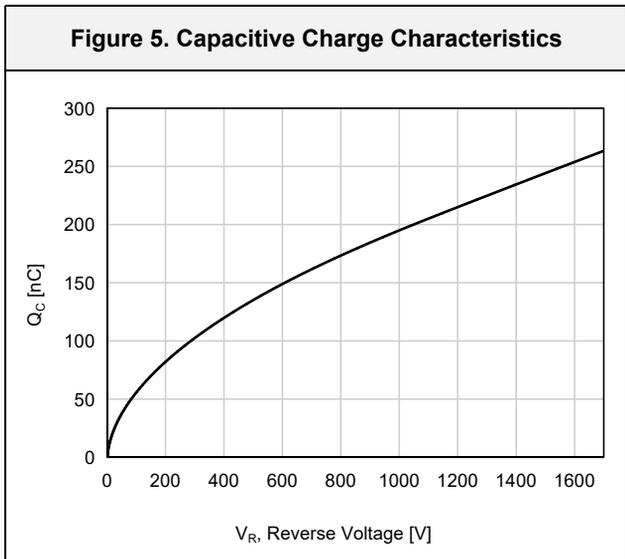
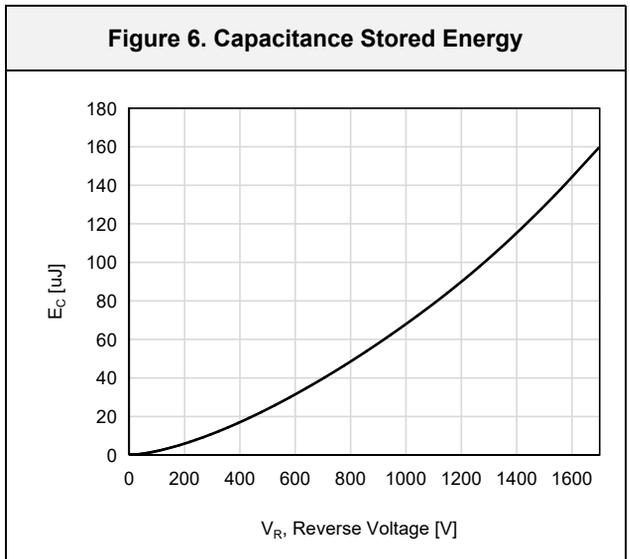


Figure 6. Capacitance Stored Energy



Typical Performance Characteristics

Figure 7. Capacitance Characteristics

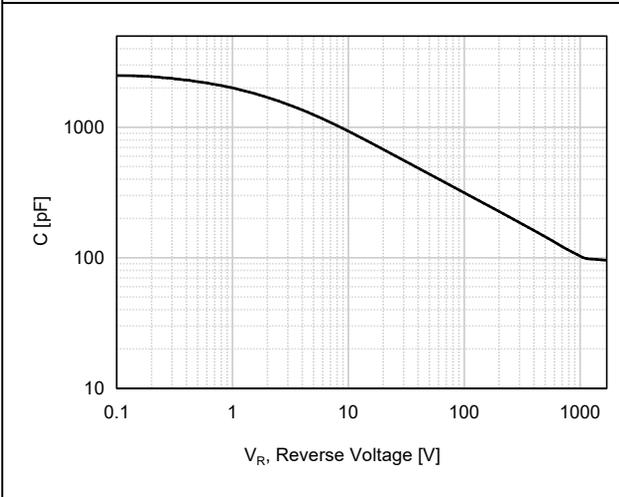
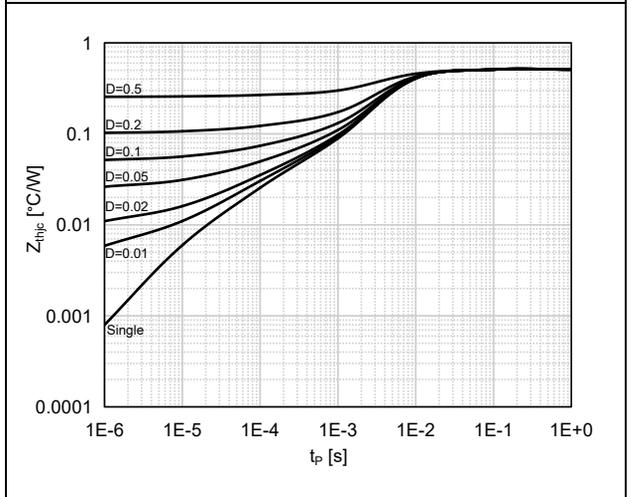
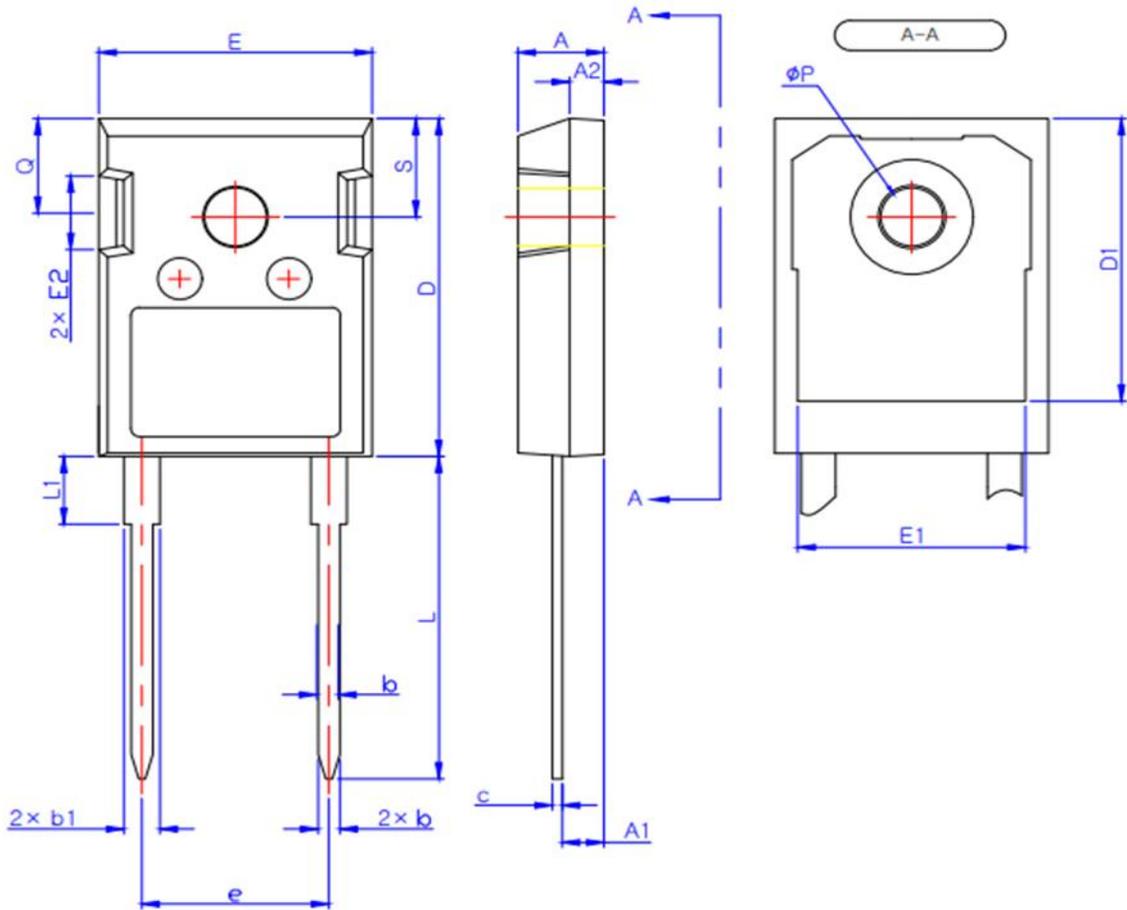


Figure 8. Transient Thermal Response Curve



Package Outlines
TO-247-2L



SYMBOL	MIN	MAX
A	4.80	5.20
A1	2.29	2.54
A2	1.90	2.10
b	1.10	1.30
b1	1.91	2.20
c	0.50	0.70
D	20.80	21.34
D1	17.43	17.83
E	15.75	16.13
E1	13.06	13.46
E2	4.32	4.83
e	10.90 BSC	
L	19.85	20.25
L1	-	4.49
phi P	3.55	3.65
Q	5.59	6.19
S	6.15 BSC	

* Dimensions in millimeters